

# SANYO Semiconductors

# DATA SHEET

N-Channel Silicon MOSFET

# FW813 — General-Purpose Switching Device Applications

#### **Features**

- ON-resistance RDS(on)1=39m $\Omega$  (typ.)
- · 4V drive
- · Nch + Nch MOSFET

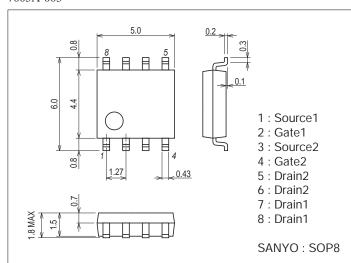
## **Specifications**

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		60	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		5	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	52	А
Allowable Power Dissipation	PD	When mounted on ceramic substrate (2000mm²x0.8mm) 1unit, PW≤10s	2.3	W
Total Dissipation	PT	When mounted on ceramic substrate (2000mm <sup>2</sup> ×0.8mm), PW≤10s	2.5	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### **Package Dimensions**

unit : mm (typ) 7005A-003

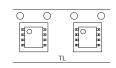


#### **Product & Package Information**

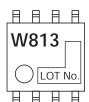
• Package : SOP8

JEITA, JEDEC : SC-87, SOT96
Minimum Packing Quantity : 1,000 pcs./reel

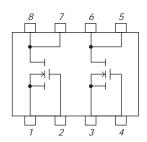
# Packing Type: TL



### Marking



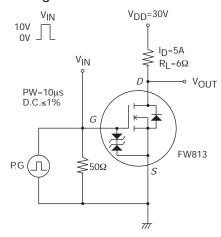
#### **Electrical Connection**

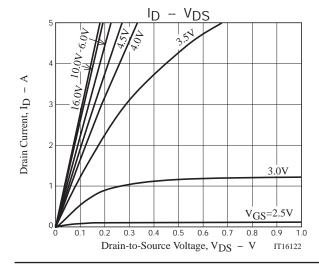


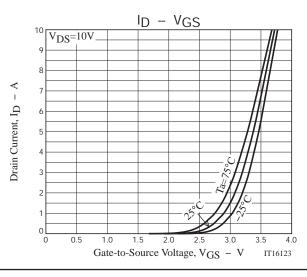
#### Electrical Characteristics at Ta=25°C

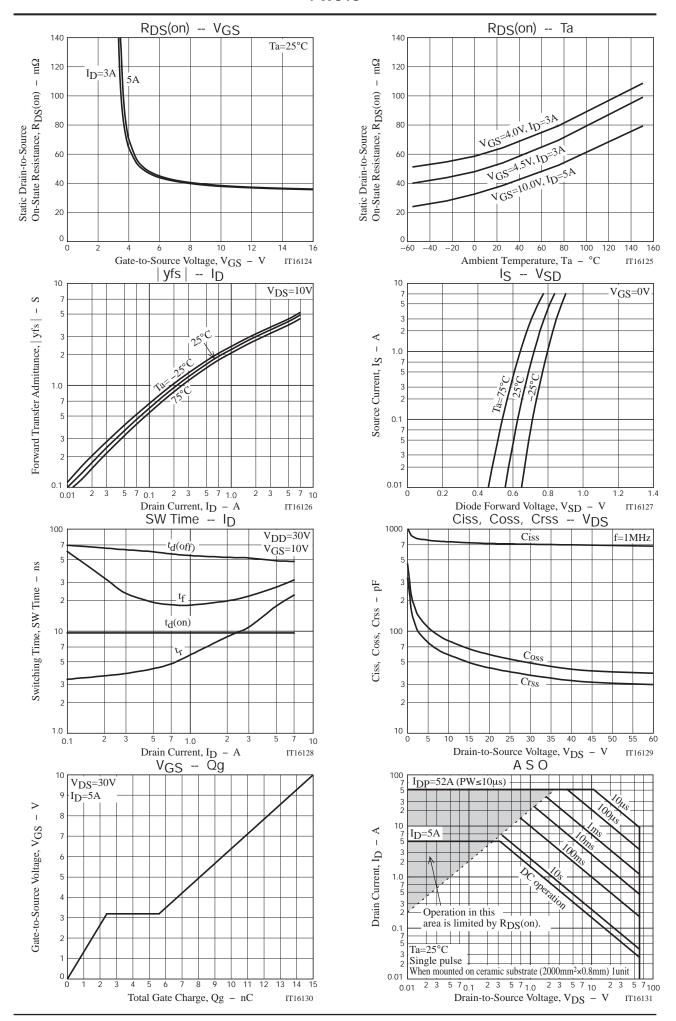
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	60			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±16V, V <sub>DS</sub> =0V			±10	μΑ
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =5A		4.2		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	I <sub>D</sub> =5A, V <sub>GS</sub> =10V		39	49	$m\Omega$
	R <sub>DS</sub> (on)2	I <sub>D</sub> =3A, V <sub>GS</sub> =4.5V		54	76	$m\Omega$
	R <sub>DS</sub> (on)3	I <sub>D</sub> =3A, V <sub>GS</sub> =4V		64	90	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> =20V, f=1MHz		725		pF
Output Capacitance	Coss	V <sub>DS</sub> =20V, f=1MHz		60		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =20V, f=1MHz		45		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		9.6		ns
Rise Time	tr	See specified Test Circuit.		18		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		49		ns
Fall Time	t <sub>f</sub>	See specified Test Circuit.		27		ns
Total Gate Charge	Qg	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A		15		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A		2.4		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A		3.2		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =5A, V <sub>GS</sub> =0V		0.81	1.2	V

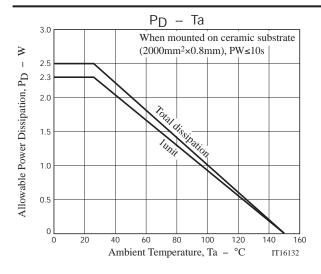
# **Switching Time Test Circuit**

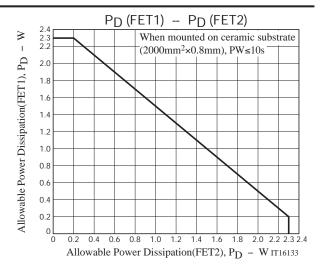












Note on usage: Since the FW813 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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